# **Xyce**<sup>™</sup> Parallel Electronic Simulator Release Notes

Release 3.0

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## Xyce<sup>™</sup> Parallel Electronic Simulator Release Notes Release 3.0

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## Scope/Product Definition

The **Xyce** Parallel Electronic Simulator has been written to support, in a rigorous manner, the simulation needs of the Sandia National Laboratories electrical designers. Specific requirements include, among others, the ability to solve extremely large circuit problems by supporting large-scale parallel computing platforms, improved numerical performance and object-oriented code design and implementation.

The **Xyce** release notes describe:

- Hardware and software requirements
- New features and enhancements
- Any defects fixed since the last release

Current known defects and defect workarounds

For up-to-date information not available at the time these notes were produced, please visit the **Xyce** web page at <a href="http://www.cs.sandia.gov/xyce">http://www.cs.sandia.gov/xyce</a>.

#### Hardware/Software

This section gives basic information on supported platforms and hardware and software requirements for running **Xyce** 3.0.

#### Supported Platforms

**Xyce** 3.0 currently supports any of the following operating system (all versions imply the earliest supported – **Xyce** generally works on later versions as well) platforms. These platforms are supported in the sense that they have been subject to certification testing for the **Xyce** version 3.0 release.

- SGI IRIX<sup>®</sup> 6.5.3, Workshop Compilers 7.4.2 (serial and parallel using SGI MPI)
- Redhat Linux<sup>®</sup>, Enterprise version 9.0 on Intel Pentium<sup>®</sup> architectures (serial and parallel using MPICH version 1.2.5.2 or LAM MPI version 7.0.6)
- Tru64 on HP/Compag Alpha<sup>®</sup> (serial and parallel)
- FreeBSD on Intel Pentium<sup>®</sup> architectures (serial and parallel using MPICH or LAM MPI)
- Microsoft Windows<sup>®</sup> (serial)
- Apple<sup>®</sup> OS X (serial)

#### Build Capability but Not Supported

The platforms listed in this section are "not supported" in the sense that they are not subject to nightly regression testing, and they also were not subject to certification testing for the **Xyce** version 3.0 release. For large parallel platforms, such as ASCI White, this sort of testing is not a realistic option. These platforms are supported in the sense that **Xyce** 3.0 has been built for these platforms, and successfully executed on them. If a user needs to run **Xyce** 3.0 on one of these platforms, contact the **Xyce** team and we will work with you on a case-by-case basis.

- ASCI White (IBM) (parallel)
- Sandia Institutional Computational Clusters (serial and parallel).

#### Hardware Requirements

The following are estimated hardware requirements for running **Xyce**:

- 128MB memory recommended, 64 MB memory minimum *memory requirements* increase with circuit size
- 50MB disk space (not including space needed for output files)

#### Software Requirements

Several libraries (all freely available from Sandia National Laboratories and other sites) are required to build **Xyce** on a platform. These are only required when building **Xyce** from source. These are:

- Trilinos Solver Library (Sandia, http://software.sandia.gov/Trilinos). This is a suite of libraries including Amesos, KLU, AztecOO, Belos, Epetra, EpetraExt, Ifpack, NOX, LOCA, and y12m.
- SuperLU (http://www.nersc.org)
- Xyce Expression library (libexpr.a).
- BLAS (libblas.a).
- LAPack (liblapack.a).

For parallel builds, the following are additionally required:

- MPI (http://www-unix.mcs.anl.gov/mpi/) library for message passing (version 1.1 or higher), such as MPICH or LAM. The version used to build Xyce must be the same that is used for building Trilinos.
- Zoltan (Sandia, <a href="http://www.cs.sandia.gov/Zoltan">http://www.cs.sandia.gov/Zoltan</a>) and its associated libraries (libzoltan.a, libzoltanCPP.a, libparmetis.a, libmetis.a)

## **Xyce** Release 3.0 Documentation

The following **Xyce** documentation is available at the **Xyce** internal website in pdf form. Some of this documentation is in "Draft" mode and is incomplete.

- **Xyce** Users' Guide, Version 3.0
- **Xyce** Reference Guide, Version 3.0

- Xyce Release Notes, Version 3.0
- Xyce Theory Document
- Xyce Test Plan

#### New Features and Enhancements

This release is the first release following the Version 2.1 release. It encompasses many key bug fixes as well as key robustness and performance enhancements. Highlights for this release include:

- Stability enhancements to the prompt photocurrent models and additional photocurrent models.
- Enhanced MOSFET-based homotopy algorithms for DCOP solution.
- New device models: BSIMSOI, pn-junction photocurrent source, JFET Level 2, MES-FET, generic switch.
- More advanced temperature compensation for JFET, MESFET, capacitor, inductor.
- Improved numerical stability in the level-1 JFET, and VDMOS devices.
- Improved parser scalability, and error reporting.
- Updated Trilinos solver library.
- New, variable-order, variable stepsize time integrator (optional).
- Support for linking Xyce to IC-CAP.
- Support for random numbers in expressions via the RAND() function.

For details of each of these new features, see the **Xyce** Users' Guide, and the **Xyce** Reference Guide.

#### **Device Support**

Table 1 contains a complete list of devices for **Xyce** Release 3.0. A number of the devices have been revised to improve robustness, and additional model levels for some devices have been added (the level=2 JFET and the level=10 MOSFET). Two new device types, the MESFET and the generic switch have also been added for **Xyce** Release 3.0.

Device	Comments
Capacitor	Age-aware, semiconductor

Device	Comments
Inductor	Nonlinear mutual inductor (see below)
Nonlinear Mutual Inductor	Sandia Core model (not fully PSpice compatible) New!
Norminear Mataar maactor	Stability improvements.
Resistor	Semiconductor
Diode (Level 1)	
Diode (Level 3)	Prompt photocurrent radiation model
Diode (Level 4)	New! Generic photocurrent source model
Independent Voltage Source (VSRC)	
Independent Current Source (ISRC)	
Voltage Controlled Voltage Source	
(VCVS)	
Voltage Controlled Current Source	
(VCCS)	
Current Controlled Voltage Source	
(CCVS) Voltage Controlled Current Source	
(CCCS)	
Nonlinear Dependent Source (B	
Source)	
Bipolar Junction Transistor (BJT)	
(Level 1)	
Bipolar Junction Transistor (BJT)	Prompt photocurrent radiation model.
(Level 2) Bipolar Junction Transistor (BJT)	
(Level 3)	Neutron-effects model.
Bipolar Junction Transistor (BJT)	Down to be to a second or first to a second of the second
(Level 4)	Prompt photocurrent radiation model (same as level 2).
Junction Field Effect Transistor	SPICE-compatible JFET model.
(JFET) (Level 1)	of fee companion of 21 model.
Junction Field Effect Transistor	New! Shockley JFET model.
(JFET) (Level 2) MESFET	Manul
	New!
MOSFET (Level 1)	
MOSFET (Level 3)	
MOSFET (Level 9)	BSIM3 model. New! Initial condition support.
MOSFET (Level 10)	New! BSIM SOI model with initial condition support.
MOSFET (Level 18)	VDMOS model.
MOSFET (Level 19)	VDMOS photocurrent model.

Device	Comments
Transmission Line	Lossless.
Controlled Switch (S,W)	New! Voltage or current controlled.
(VSWITCH/ISWITCH)	
Generic Switch (SW)	New! Controlled by an expression.
PDE Devices (Level 1)	one-dimensional
PDE Devices (Level 2)	two-dimensional

Table 1: Devices Supported by Xyce.

#### Robustness Improvements

- Improvement of homotopy algorithms has for large MOSFET circuits, including SOI circuits.
- The radiation models (Level 3 Diode and Level 2 BJT) have been made less susceptible to roundoff error, and now support breakpoints for discontinuity capturing.

#### **New Device Types**

- The SPICE-compatible MESFET model.
- A generic switch device, which can be controlled by current, voltage or an expression.

#### New Model Levels

- The level 4 photocurrent BJT introduced in Release 2.1 has replaced the Level 2 of previous releases in Release 3.0 the level 2 BJT is the same as the level 4.
- Level 10 MOSFET, Berkeley BSIM SOI (Silicon on Insulator) model version 3.2.
- Level 9 and 10 MOSFET's support initial conditions on junction voltages.
- The level 4 diode is a generic pn-junction photocurrent source. It can be used to introduce basic photocurrent effects in any device that has a PN junction. It contains only the photocurrent source terms from the level 3 diode.
- Level 2 JFET, based on Shockley's original formulation that is more accurate than the SPICE-compatible Level 1 JFET.

#### Improved Temperature Compensation

■ The JFET and MESFET employ quadratic temperature coefficients for the DC model parameters. The temperature coefficients must be obtained from data by parameter extraction in the same way the other model parameters are obtained.

■ The capacitor and inductor now have quadratic temperature coefficients.

#### **Enhanced Solver Stability and Features**

- Xyce now uses an enhanced version of the Trilinos solver library version 4.0.
- The KLU direct linear solver, which was specifically designed for circuits, is now the default in Xyce. KSPARSE, the previous default solver, remains available and can be selected with a command line option or netlist command.
- A new variable-order (maximum order=5), variable timestep time integrator is available in **Xyce**. This time integrator is not the default, but can be enabled from the command line. This new time integrator can potentially run much faster than the default time integrator, particularly on oscillatory circuits.

#### Interface Improvements

- The netlist parser has been further optimized for large parallel runs.
- Current through two lead devices and lead currents in three or more lead devices can be output in .PRINT line.
- Support for \*.raw output files.
- Support for linking Xyce to IC-CAP.

## Defects of Release 2.1 Fixed in this Release

Defect	Description
	Breakpoints are now generated from time dependent
Breakpoints are not generated for dependent sources. [Bug 265]	expression in dependent sources. This corrects many problems where critical circuit behavior from events was previously missed.
Parsing errors can lead to parallel	Error handling has been greatly improved for parallel
hangs. [Bug 765]	runs.
Node/device name collisions cause	Name collisions and duplicate names are now detected
catastrophic erors. [Bug 767]	early, and exit cleanly with informative fatal errors.
Incomprehensible errors when	
nodes are used in .param expressions. [Bug 769]	Error handling for this illegal usage is now informative.
Incorrect substitution of nodes in	Errors that occurred when the names of substituted
.subckt. [Bug 785]	and other nodes were coincidentally the same on the .subckt line are corrected.
Mulitply-coupled Mutual Inductances	Errors could occur when multiple inductors (more than
not coupled correctly. [Bug 677]	two) were coupled together. This was a parsing error which has been fixed.
DOS-Style line breaks cause	The windows build of Xyce 2.1 had trouble with
mis-parsing of input [Bug 689]	DOS-style line breaks. This has been fixed for Xyce 3.0.
Add temperature effects to capacitor	Quadratic temperature compensation added to these
and inductor. [Bug 644]	devices.
Initial JFET voltage drops imposed incorrectly. [Bug 674]	This problem has been corrected.
JFET Capacitor currents not handled correctly. [Bug 669]	This bug has been fixed and verified.
Limiter functions used by the JFET are inconsistent with SPICE. [Bug	The bug is fixed and marked verified.
670]	
Use of gmin in the JFET not	This problem has been fixed.
consistent. [Bug 675]	This problem has been had.
Fix MESFET with respect to capgs	Bug is fixed and verified.
and also gm. [Bug 684]	Dag is fixed and verified.

Table 2: Fixed Defects.

## Known Defects and Workarounds

Defect	Description
	.DC sweep calculation does not automatically output
.DC sweep output.	sweep results.  Workaround: Use .PRINT statement to output sweep variable results.
Failure for netlists using ChileSPICE	Xyce does not currently support the use of digital
digital primitives.	primitives.
BJT Current Crowding	"Timestep too small" failures can result when IRB nonzero with level 2 and level 4 BJT Workaround: If such failure observed, disable current crowding effect by setting IRB to zero in all BJT models. Please feed back such circuits to the <b>Xyce</b> development team so that this bug can be characterized and eliminated.
Microsoft Windows installation restrictions	Users with insufficient privileges (i.e.  Limited Account) are not permitted to install <b>Xyce</b> into folders on the System Drive (usually C:).  Workaround: First, manually create the desired folder on the System Drive. It is then possible to install <b>Xyce</b> into this folder by following the standard Setup procedure.
MPICH parallel runs may not exit cleanly	<b>Xyce</b> may not exit cleanly if it encounters certain errors during parsing.  Workaround: If <b>Xyce</b> appears to hang, manually terminate each process. Usually a SIGTERM or ^C is sufficient to halt the job. Users running on the Alpha should manually check for zombie processes after <b>Xyce</b> error exits, and kill them if necessary.
Incompatible proprietary file formats.	Netlists created with programs like Microsoft Word and Microsoft Wordpad will not run in <b>Xyce</b> . <b>Xyce</b> does not recognize proprietary file formats. <i>Workaround</i> : It is best not to use such programs to create netlists, unless netlists are saved as *.txt files. If you must use a Microsoft editor, it is better to use Microsoft Notepad. In general, the best solution is to use a Unix-style editor, such as Vi, Gvim, or Emacs.  Specifying expressions in the .PRINT line is a new
Expressions in the .PRINT line can't use variables specified by .PARAM statements.	Xyce capability. It is very useful, but is unable to use .PARAM variables.  Workaround: For now, the only solution is to not use .PARAM variables in .PRINT statement expressions.  This will be fixed for a later release.

Defect	Description
	There is one case for a customer's parallel run of a
One known instance of restart results not matching original run results.	large digital circuit of BSIM3's where the restart output does not match the original results for the same time range.  Workaround: The only choice for now is to check the restart results against the baseline results for some block if the run results have a very tight tolerance for success. It is suggested to overlap the original run time with the restart time allowing comparison.
Duralisate rade names in grangum	Duplicate node names in a .SUBCKT specification will
Duplicate node names in .SUBCKT [bug 784]	lead to incorrect results. Users must take care that all nodes specified on a .SUBCKT line are unique in Xyce 3.0.
	Use of lead currents in B/E/F/G/H source and switch
Lead currents in B/E/F/G/H source and switch expressions [bug 801]	expressions will lead to incorrect results. A fatal diagnostic should be generated for such usage, but is not. The only supported use of lead currents is on .PRINT lines in Xyce 3.0.
	The test for duplicate devices improperly reports that
Use of multiple YPDE, YDAC, and YADC devices improperly flagged as duplicate device error [Bug 803]	two Y devices of the same type are duplicates of each other without checking the second field (where the actual device name is). This will be fixed in the minor update release (Xyce 3.0.1). In the meantime, the only workaround is to place the devices in separate subcircuits, in which case they will be prefixed with the subcircuit name and not mistakenly identified as duplicates.

Table 3: Known Defects and Workarounds.

## Incompatibilities With Other Circuit Simulators

Issue	Comment
.SAVE does not work.	Xyce does not support this. Use .PRINT instead.
.OP is not complete	A . OP netlist will run in Xyce, but will not produce the
	extra output normally associated with the .OP statement.
	A requested pulsed source rise/fall time of zero really is
Pulsed source rise time of zero.	zero in Xyce. In other simulators, requesting a zero rise/fall time causes them to use the printing interval found on the .TRAN line.
Mutual Inductor Model.	Not the same as PSpice. This is a Sandia developed
	model but is compatible with Cadence PSpice parameter set.
	Output variables have to be specified as V(node) or
.PRINT line shorthand.	I(source). Specifying the node alone will not work. Also, specifying V(*) or I(*) (to get all voltages or currents) will not work.
BSIM3 level.	In <b>Xyce</b> the BSIM3 level=9. Other simulators have
	different levels for the BSIM3.
BSIM SOI v3.2 level.	In <b>Xyce</b> the BSIM SOI (v3.2) level=10. Other
	simulators have different levels for the BSIM SOI.  Currently, circuit nodes and devices MUST have
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Node names vs. device names.	different names in <b>Xyce</b> . Some simulators can handle a device and a node with the same name, but <b>Xyce</b> cannot.
Interactive mode.	Xyce does not have an interactive mode.
	These are not currently supported within <b>Xyce</b> .
ChileSPICE-specific "operating point	However
	<b>Xyce</b> does support "IC= <value>" statements for</value>
voltage sources."	capacitors, inductors, and the two BSIM devices which will automatically set these voltage drops at the
	beginning of a transient simulation.
	The manner of specifying a model parameter to be
Syntax for .STEP is different.	swept is slightly different. Also, it is not possible to do a .STEP sweep over a global parameter. See the Users' and Reference Guides for details.

Table 4: Incompatibilities with other circuit simulators.

## Important Changes to **Xyce** Usage Since the Last Release.

Table 5 lists some usage changes for **Xyce**.

Issue	Comment
The TCAD/PDE devices no longer	This has been changed to "YPDE". This was done to
use the letter "Z" as their identifier in the nelist.	allow for the MESFET to use the letter "Z", to maintain compatibility with SPICE. [Bug 655]

Table 5: Changes to netlist specification since the last release.

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